HALOGEN

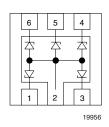
FREE

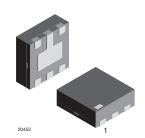
GREEN



Vishay Semiconductors

5-Line ESD Protection Diode Array in LLP75





MARKING (example only)



Dot = pin 1 marking XX = date code YY = type code (see table below)

DESIGN SUPPORT TOOLS

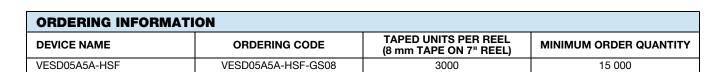
Models





FEATURES

- Ultra compact LLP75-6L package
- Low profile < 0.6 mm
- 5-line ESD protection
- Low leakage current $I_R < 0.1 \mu A$
- Low load capacitance C_D = 13 pF
- ESD immunity acc. IEC 61000-4-2 ± 15 kV contact discharge ± 15 kV air discharge
- Working voltage range V_{RWM} = 5 V
- e4 precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



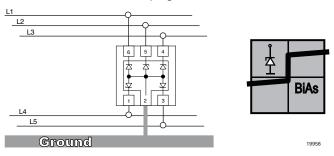
PACKAGE DA	TA									
DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS				
VESD05A5A-HSF	LLP75-6L	AR	4.2 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C				

ABSOLUTE MAXI	MUM RATINGS VESD05A5A-HSF				
PARAMETER	TEST CONDITIONS			VALUE	UNIT
Peak pulse current	BiAs-mode: each input (pin 1 to pin 6) to ground (pin acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; single shot	- I _{PPM}	2.5	Α	
	BiSy-mode: each input (pin 1 to pin 6) to any other input Pin 2 not connected. Acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; sing		2.5	Α	
Pook pulso power	BiAs-mode: each input (pin 1 to pin 6) to ground (pin acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; single shot	2);	- P _{PP}	33	W
Peak pulse power	BiSy-mode: each input (pin 1 - pin 6) to any other input Pin 2 not connected. Acc. IEC 61000-4-5; t_p = 8/20 μ s; sing	Грр	43	W	
ESD immunity	acc. IEC61000-4-2; 10 pulses	Contact discharge	- V _{ESD}	± 15	15 kV
LOD IIIIIIIIIIIII	BiAs-mode: each input (pin 1 to pin 6) to ground (pin 2)	Air discharge	VESD	± 15	kV
ESD immunity	acc. IEC 61000-4-2; 10 pulses BiSy-mode: each input (pin 1 to pin 6) to any other input pin.	Contact discharge	V _{ESD}	± 10	kV
LOD IIIIIIIIIIIII	Pin 2 not connected.	Air discharge	VESD	± 10	kV
Operating temperature	Junction temperature		T_J	-40 to +125	°C
Storage temperature			T _{STG}	-55 to +150	°C

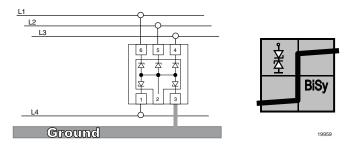


APPLICATION NOTE:

a. With the VESD05A5A-HSF 5 different signal or data lines can be clamped to ground. Due to the different clamping levels in forward and reverse direction the VESD05A5A-HSF clamping behavior is bidirectional and asymmetrical (BiAs).



b. If symmetrical clamping behaviour is required the VESD05A5A-HSF can also be used as a bidirectional symmetrical protection device protecting up to 4 lines. In this case pin no. 2 must not be connected.



PARAMETER	erwise specified) TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	5	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5	V
Reverse voltage	at I _R = 0.1 μA	V_{R}	5	-	-	V
Max. reverse current	at V _R = 5 V	I _R	-	< 0.01	0.1	μΑ
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	6	6.7	7.5	V
Reverse clamping voltage	at I _{PP} = 1 A	V_{C}	-	9	10	V
	at I _{PP} = I _{PPM} = 2.5 A	V _C	-	12	13	V
Forward clamping voltage	at I _{PP} = 1 A	V_{F}	-	2	2.5	V
	at I _{PP} = I _{PPM} = 2.5 A	V_{F}	-	3.2	4	V
12	at $V_R = 0 V$; $f = 1 MHz$	C _D	-	13	15	pF
Line capacitance	at V _R = 2.5 V; f = 1 MHz	C _D	-	8	-	pF

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

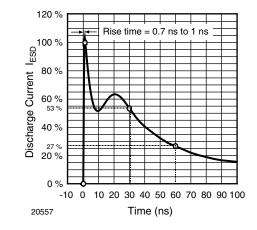


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω /150 pF)

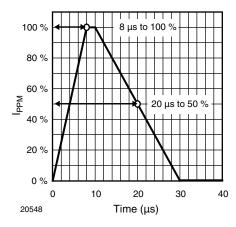


Fig. 2 - 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5

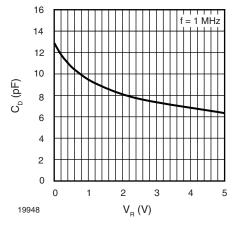


Fig. 3 - Typical Capacitance C_{D} vs. Reverse Voltage V_{R}

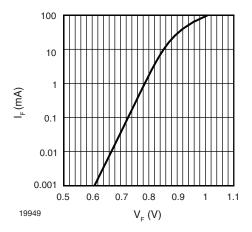


Fig. 4 - Typical Forward Current I_{F} vs. Forward Voltage V_{F}

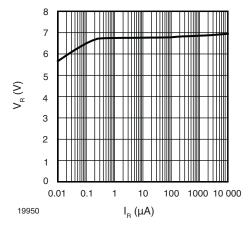


Fig. 5 - Typical Reverse Voltage V_R vs. Reverse Current I_R

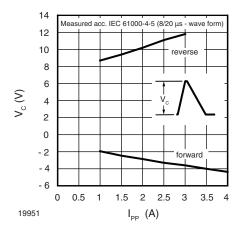


Fig. 6 - Typical Peak Clamping Voltage V_C vs. Peak Pulse Current I_{PP}



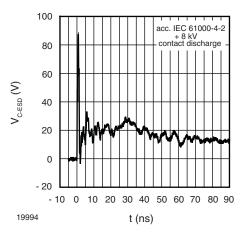


Fig. 7 - Typical Clamping Performance at + 8 kV Contact Discharge (acc. IEC 61000-4-2)

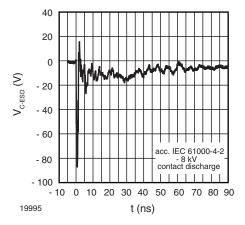


Fig. 8 - Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)

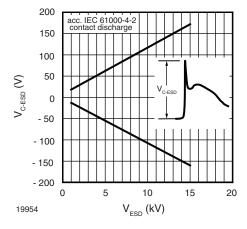
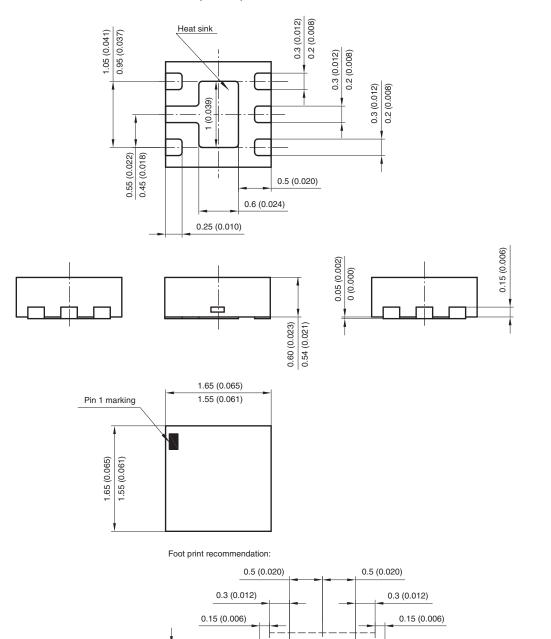


Fig. 9 - Typical max. Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)

Solder resist mask

Solder pad

PACKAGE DIMENSIONS in millimeters (Inches): LLP75-6L



Document no.:S8-V-3906.02-010 (4) Created - Date: 04. MAY 2005 Rev. 4 - Date: 21. March 2006 20454 (0.039)

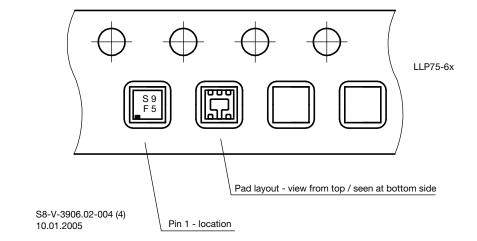
0.5 (0.020)

1 (0.039)

0.5 (0.020)

0.25 (0.010)







Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.